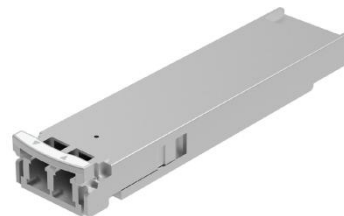


10G CWDM XFP 80km Industrial Optical Transceivers GXC-xx192-08T

Features

- Hot-pluggable XFP form factor
- Full-duplex transceiver modules
- Cooled EML transmitter and APD receiver
- No Reference Clock required
- Compliant with XFP MSA
- Data rate from 9.95Gbps to 11.3Gbps
- 1470nm-1570nm CWDM wavelengths (20nm spacing)
- Reach up to 80km over SMF
- Power consumption < 2.5W
- Dual LC receptacles
- Built-in digital diagnostic functions
- Operating case temperature range from -40°C to +85°C
- 3.3V power supply voltage
- RoHS compliant (lead free)



Applications

- 10G Ethernet
- 10G Fibre Channel
- OTN OTU2e
- SONET OC-192 / SDH STM-64

Description

The Gigalight 10G CWDM XFP 80km industrial optical transceivers (GXC-xx192-08T) are designed for 10G Ethernet, 10G Fibre Channel, OTN OTU2e and SONET OC-192 / SDH STM-64 links reach up to 80km over Single-Mode Fiber (SMF). The transmitter section incorporates a cooled EML laser, while the receiver section consists of a APD photo-diode integrated with a TIA. All modules satisfy class I laser safety requirements. The Gigalight 10G DWDM XFP modules provide an enhanced monitoring interface, which allows real-time access to device operating parameters such as transceiver temperature, laser bias current, transmitted optical power, received optical power and transceiver supply voltage.

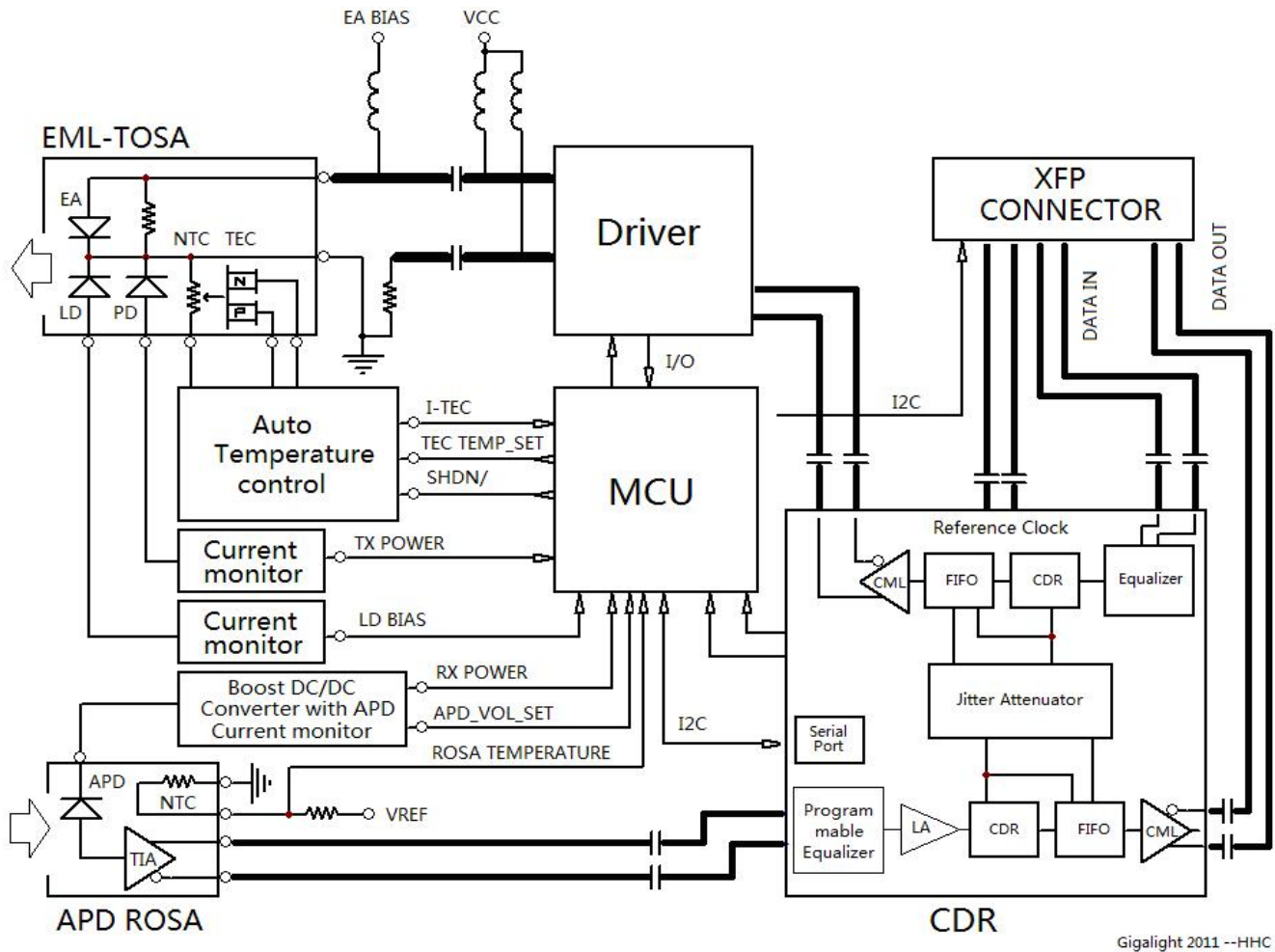


Figure 1. Module Block Diagram

Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc3	-0.5	4.0	V
Storage Temperature	Tst	-40	85	°C
Case Operating Temperature	Top	-40	85	°C

Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit
Supply Voltage	Vcc3	3.13	3.3	3.47	V
Supply current	Icc3	-	500	720	mA
Operating Case temperature	Tca	-40	-	85	°C
Module Power Dissipation	Pm	-	1.8	2.5	W

Transmitter Specifications – Optical

Parameter	Symbol	Min	Typical	Max	Unit
Center Wavelength	c				nm
Center wavelength stability	d				nm
Optical Transmit Power	Po	0	-	+4	dBm
Optical Transmit Power	PTX_DIS	-	-	-30	dBm
Extinction Ratio	ER	9	-	-	dB
Jitter Generation(P-P)	JG P-P	-	-	0.1	UI
Jitter Generation(RMS)	JG RMS	-	-	0.01	UI
Spectral Width (-20dB)	$\Delta \lambda$ 20	-	-	0.3	nm
Side Mode Suppression Ratio	SMSR	30	-	-	dB
Dispersion	DP	-	-	3	dB
Relative Intensity Noise	RIN	-	-	-130	dB/Hz
Eye Mask	Compliant with ITU-T G.691 STM-64 eye mask				

Notes:

1. Wavelength stability is achieved within 60 seconds (max) after power up.
2. 1470nm, 1490nm, 1510nm, 1530nm, 1550nm, 1570nm.

Transmitter Specifications – Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Input differential impedance	Rim	-	100	-	Ω
Differential data Input	VtxDIFF	120	-	850	mV
Transmit Disable Voltage	VD	2.0	-	Vcc3+0.3	V
Transmit Enable Voltage	Ven	0	-	+0.8	V
Transmit Disable Assert Time	Vn	-	-	10	us

Receiver Specifications – Optical

Parameter	Bit Rate	BER	Symbol	Min	Typica	Max	dBm
Sensitivity (0km)	9.95-10.7	$<10^{-12}$	Rsen		-	-26	dBm
	11.1	$<10^{-12}$	Rsen			-25	dBm
		$<10^{-4}$	Rsen			-28	dBm
	11.3	$<10^{-4}$	Rsen			-28	dBm
Sensitivity (80km)	9.95-10.7	$<10^{-12}$	Rsen			-23	dBm
	11.1	$<10^{-12}$	Rsen			-22	dBm
Maximum Input Power			RX-overload	-7	-	-	dBm
Input Operating Wavelength			λ	1260	-	1600	nm

Reflectance			Rrx	-	-	-27	dBm
Loss of Signal Asserted			LOS_A	-37	-	-30	dBm
LOS De-Asserted			LOS_D	-	-	-28	dBm
LOS Hysteresis			LOS_H	0.5	-	-	dB

Notes:

1. Measured with ER=9 dB; PRBS 2³¹-1.
2. For 10G Ethernet application, -24dBm is equivalent to an OMA of -22.09dBm for an ER = 9 dB.

Receiver Specifications – Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Output differential impedance	Rom	-	100	--	Ω
Differential Output Swing	Vout P-P	350	-	850	mV
Rise/Fall Time[1]	Tr / Tf	24	-	40	ps
Loss of Signal –Asserted	VOH	2	-	Vcc3+0.3-	V
Loss of Signal –Negated	VOL	GND	-	GND+0.5	V

Notes:

1. Tr/Tf: 20%-80%;

Pin Descriptions

Pin	Logic	Symbol	Name/Description	Ref.
1		GND	Module Ground	1
2		VEE5	Optional -5.2 Power Supply – Not required	
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module to, respond to 2-wire serial interface commands	
4	LVTTL-O	Interrupt	Interrupt (bar); Indicates presence of an important condition which can be read over the serial 2-wire interface, open collector	2
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned off	3
6		VCC5	Not required	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock, open collector	2
11	LVTTL-	SDA	Serial 2-wire interface data line, open collector	2
12	LVTTL-O	Mod_Abs	Module Absent; Indicates module is not present. Grounded in the module.	
13	LVTTL-O	Mod_NR	Module Not Ready; open collector	2

14	LVTTTL-O	RX_LOS	Receiver Loss of Signal indicator; open collector	2
15		GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	Not required	
21	LVTTTL-I	P_Down/R ST	Power Down; When high, places the module in the low power stand-by mode and on the falling edge of P_Down initiates a module reset	
			Reset; The falling edge initiates a complete reset of the module including the 2-wire serial interface, equivalent to a power cycle.	
22		VCC2	Not required	
23		GND	Module Ground	1
24	PECL-I	RefCLK+	Reference Clock non-inverted input, AC coupled on the host board, Not required	4
25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the host board, Not required	4
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

Notes:

1. Module circuit ground is isolated from module chassis ground within the module.
2. Open collector; should be pulled up with 4.7k – 10k ohms on host board to a voltage between 3.15V and 3.6V.
3. Laser output disabled on TX_DIS > 2.0V, enabled on TDIS < 0.8V.
4. Reference Clock input is not required.

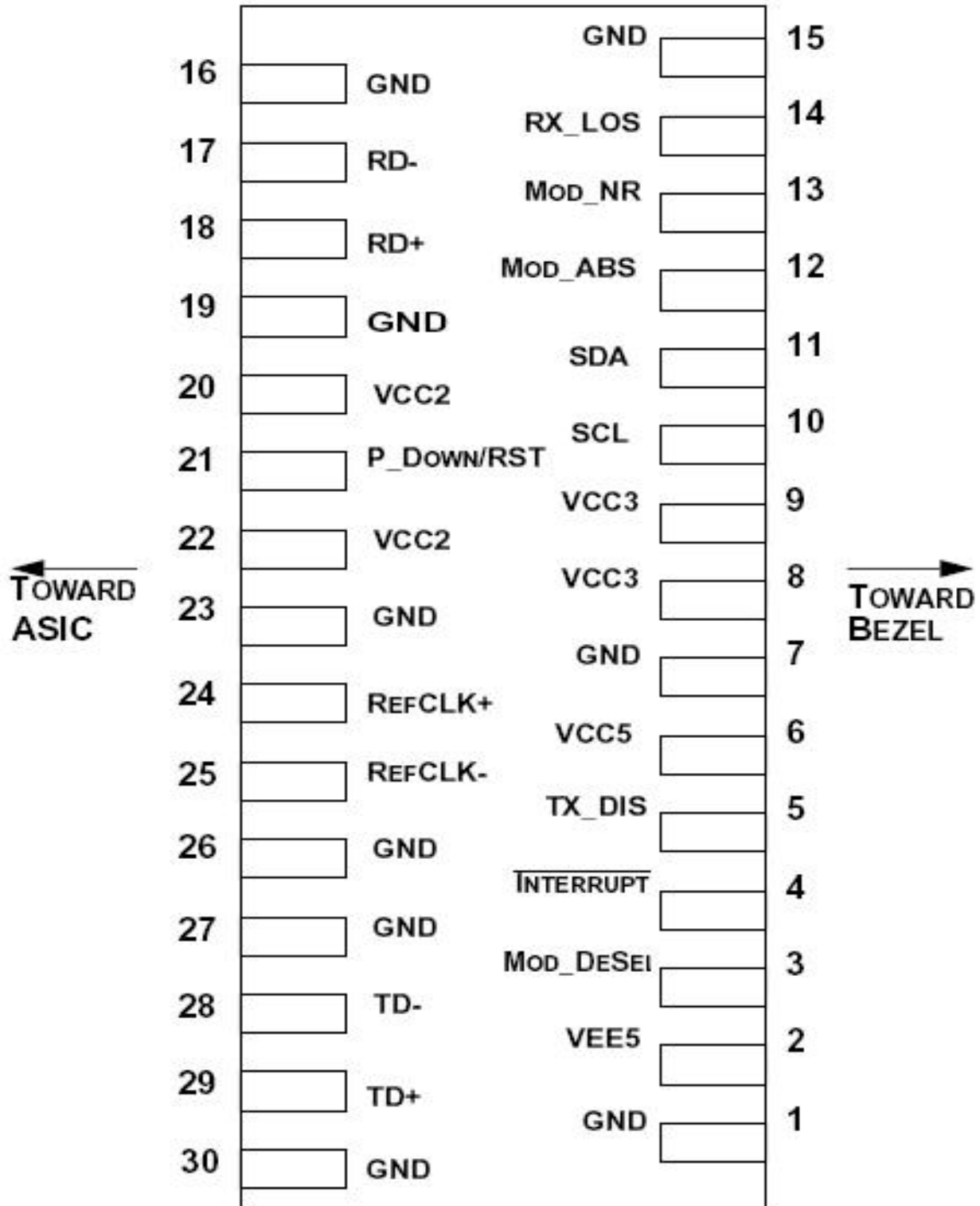


Figure 2. Electrical Pin-out Details

Mechanical Dimensions

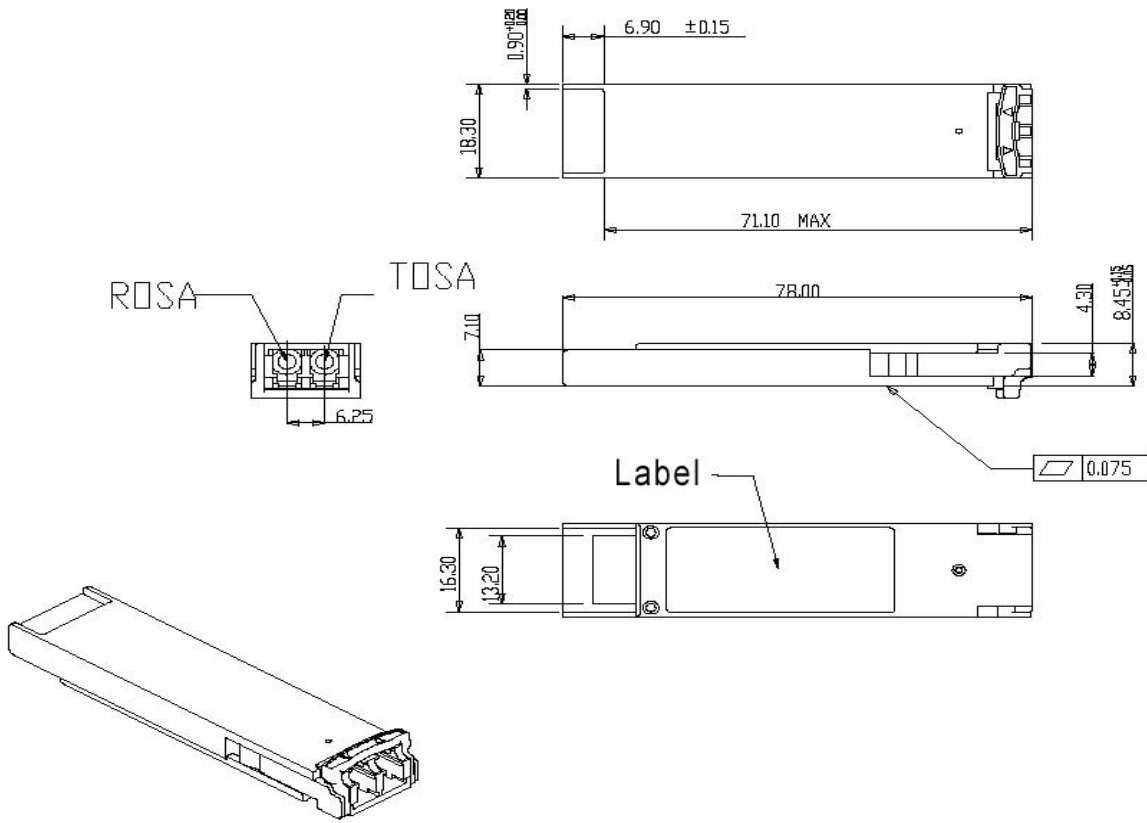


Figure 3. Mechanical Specifications

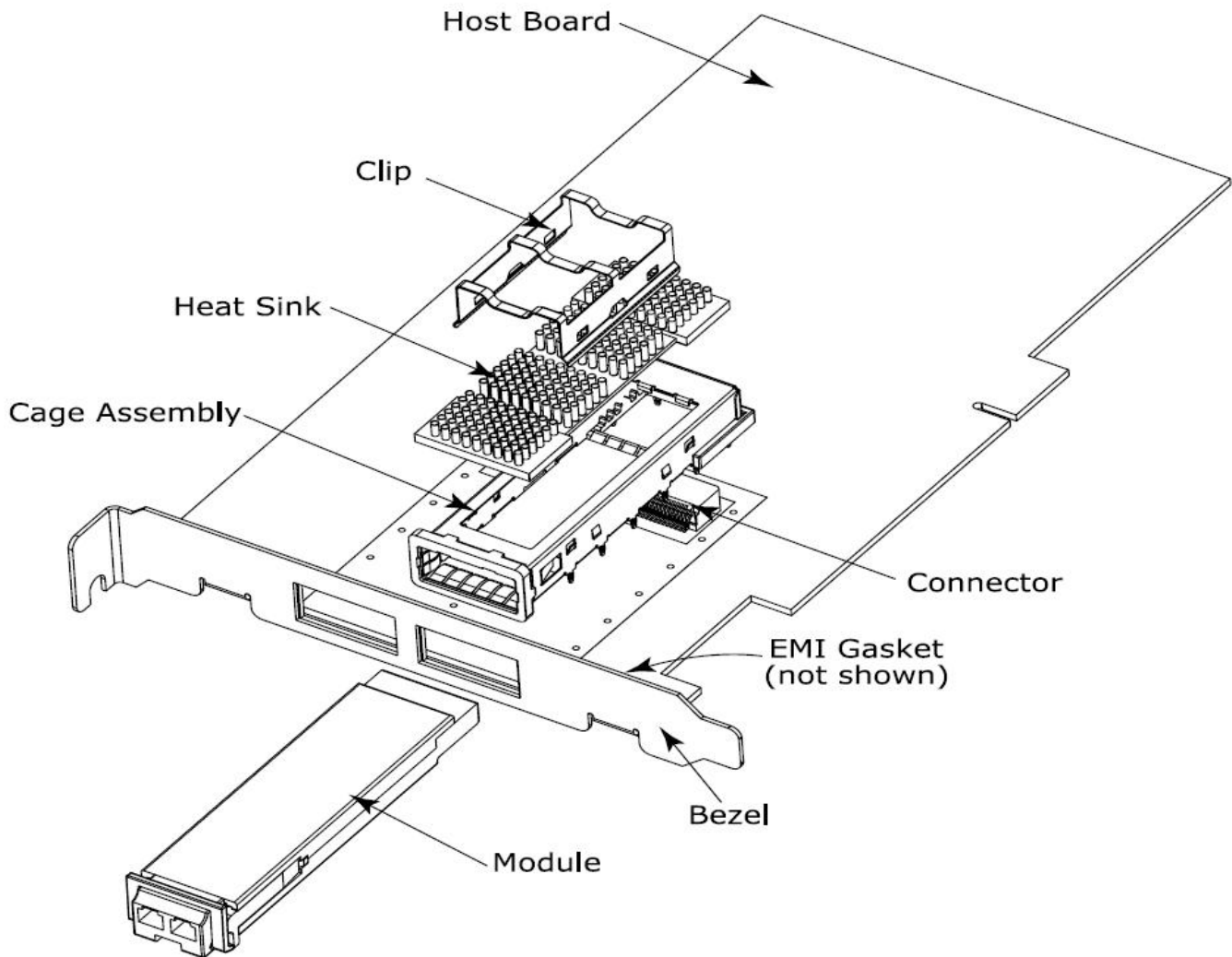


Figure 4. XFP Mechanical Components

The mechanical components defined:

1. The module, clip and connector dimensions are constant for all applications. While the bezel, cage assembly, EMI gasket and heat sink can be designed and/or adjusted for the individual application.
2. The relatively small form factor of the XFP module combined with an adaptable heatsink option allows host system design optimization of module location, heatsink shape/dimension/fins design, and airflow control. The module can be inserted and removed from the cage with the heat sink and clip attached.

Regulatory Compliance

GIGALIGHT XFP transceiver is designed to be Class I Laser safety compliant and is certified per the following standards:

Feature	Standard
Laser Safety	IEC 60825-1:2014(Third Edition)
Environmental protection	2011/65/EU
CE EMC	EN55032: 2015 EN55035: 2017 EN61000-3-2: 2014 EN61000-3-3: 2013
FCC	FCC Part 15, Subpart B; ANSI C63.4-2014

References

1. 10 Gigabit Small Form Factor Pluggable Module (XFP) Multi-Source Agreement (MSA), Rev 4.5 – August 2005. Documentation is currently available at <http://www.xfpmsa.org/>
2. IEEE802.3ae – 2002
3. ITU-T G.709 / ITU-T G.959.1 <http://www.itu.int/>
4. Telcordia GR-253-CORE

CAUTION:

Use of controls or adjustment or performance of procedures other than those specified herein may result in hazardous radiation exposure.

Ordering information

Part Number	Product Description
GXC-47192-08T	CWDM XFP, 11.3Gb/s, 1470nm, 80km, -40° C to +85° C
GXC-49192-08T	CWDM XFP, 11.3Gb/s, 1490nm, 80km, -40° C to +85° C
GXC-51192-08T	CWDM XFP, 11.3Gb/s, 1510nm, 80km, -40° C to +85° C
GXC-53192-08T	CWDM XFP, 11.3Gb/s, 1530nm, 80km, -40° C to +85° C
GXC-55192-08T	CWDM XFP, 11.3Gb/s, 1550nm, 80km, -40° C to +85° C
GXC-57192-08T	CWDM XFP, 11.3Gb/s, 1570nm, 80km, -40° C to +85° C

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Revision History

Revision	Date	Description
V0	May-21-2019	Advance Release.